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CONFIRMATION NO. 5083

SERIAL NUMBER 10/823,611	FILING DATE 04/14/2004  RULE	CLASS 029	GROUP ART UNIT 3729	ATTORNEY DOCKET NO. SOCKET 3.0-001 DIV I DIV
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APPLICANTS

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 Masayuki Ohsawa, Tokyo, JAPAN;

\*\* CONTINUING DATA \*\*\*\*\* YES *mt*  
 This application is a DIV of 10/139,237 05/07/2002 PAT 6,828,221  
 which is a DIV of 09/685,799 10/11/2000 PAT 6,528,874

\*\* FOREIGN APPLICATIONS \*\*\*\*\* YES *mt*  
 JAPAN 11-289277 10/12/1999  
 JAPAN 11-374462 12/28/1999  
 JAPAN 2000-142658 05/16/2000

IF REQUIRED, FOREIGN FILING LICENSE GRANTED \*\* SMALL ENTITY \*\*  
 \*\* 06/25/2004

Foreign Priority claimed 35 USC 119 (a-d) conditions met	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance <i>mt</i> Examiner's Signature Initials	STATE OR COUNTRY JAPAN	SHEETS DRAWING 53	TOTAL CLAIMS 814	INDEPENDENT CLAIMS 1
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Verified and Acknowledged

ADDRESS  
 038091  
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TITLE  
 Manufacturing method for wiring circuit substrate

<input type="checkbox"/> All Fees
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